# 3-to-8 line decoder/demultiplexer; inverting

Rev. 1 — 4 April 2013

**Product data sheet** 

## 1. General description

The 74LVC138A-Q100 is a 3-to-8 line decoder/demultiplexer. It accepts three binary weighted address inputs (A0, A1 and A2). When the inputs are enabled, it provides eight mutually exclusive outputs ( $\overline{Y0}$  to  $\overline{Y7}$ ) that are LOW when selected.

There are three enable inputs: two active LOW ( $\overline{E}1$  and  $\overline{E}2$ ) and one active HIGH (E3). Every output is HIGH unless  $\overline{E}1$  and  $\overline{E}2$  are LOW and E3 is HIGH.

This multiple enable function allows easy parallel expansion of the device to a 1-of-32 (5 lines to 32 lines) decoder with just four 74LVC138A-Q100 devices and one inverter. The 74LVC138A-Q100 can be used as an eight output demultiplexer by using one of the active LOW enable inputs as the data input and the remaining enable inputs as strobes. Unused enable inputs must be permanently tied to their appropriate active HIGH or LOW state.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

## 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- 5 V tolerant inputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Demultiplexing capability
- Multiple input enable for easy expansion
- Ideal for memory chip select decoding
- Mutually exclusive outputs
- Output drive capability 50 Ω transmission lines at 125 °C
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options

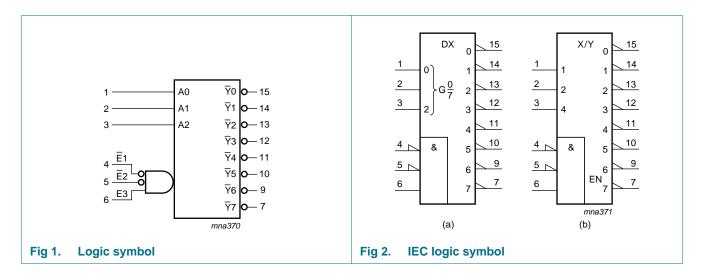


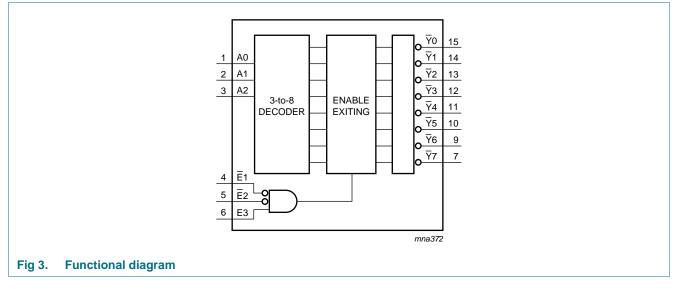
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## 3. Ordering information

Table 1.         Ordering information									
Type number	Package								
	Temperature range	Name	Description	Version					
74LVC138AD-Q100	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1					
74LVC138APW-Q100	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1					
74LVC138ABQ-Q100	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal-enhanced very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85$ mm	SOT763-1					

## 4. Functional diagram

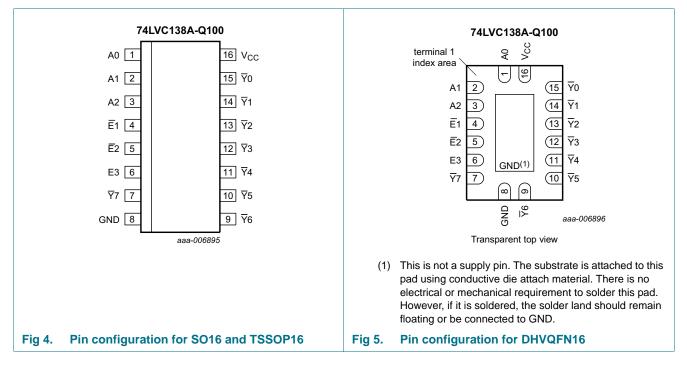




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## 5. Pinning information

#### 5.1 Pinning



### 5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
A0	1	address input
A1	2	address input
A2	3	address input
Ē1	4	enable input (active LOW)
E2	5	enable input (active LOW)
E3	6	enable input (active HIGH)
GND	8	ground (0 V)
Y[0:7]	15, 14, 13, 12, 11, 10, 9, 7	output
V <sub>CC</sub>	16	supply voltage

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## 6. Functional description

Input						Outp	Output						
E1	E2	E3	A0	A1	A2	<u>Y</u> 0	<u>Y</u> 1	<u>Y</u> 2	<u></u> ¥3	<u>¥</u> 4	<u>¥</u> 5	<u>¥</u> 6	<u>7</u> 7
Н	Х	Х	Х	Х	Х	Н	Н	Н	Н	Н	Н	н	Н
Х	Н	Х	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н
Х	Х	L	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н
L L	L	Н	L	L	L	L	Н	Н	Н	Н	Н	Н	Н
			Н	L	L	Н	L	Н	Н	Н	Н	Н	Н
		L	L	Н	L	Н	Н	L	Н	Н	Н	Н	Н
			Н	Н	L	Н	Н	Н	L	Н	Н	Н	Н
			L	L	Н	Н	Н	Н	Н	L	Н	Н	Н
			Н	L	Н	Н	Н	Н	Н	Н	L	Н	Н
			L	Н	Н	Н	Н	Н	Н	Н	Н	L	Н
			Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L

#### Table 3. Function table [1]

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care

## 7. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

				10	,
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage	output HIGH or LOW state	<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	<u>[3]</u>	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO16 packages: above 70 °C the value of P<sub>D</sub> derates linearly with 8 mW/K. For TSSOP16 packages: above 60 °C the value of P<sub>D</sub> derates linearly with 5.5 mW/K. For DHVQFN16 packages: above 60 °C the value of P<sub>D</sub> derates linearly with 4.5 mW/K.

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## 8. Recommended operating conditions

Table 5.	Recommended operating of	conditions				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub> supply voltage			1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC}$ = 1.65 V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	0	-	10	ns/V

## 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	-40 °C to	o +125 °C	Unit
			Min	Typ <mark>[1]</mark>	Мах	Min	Max	-
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	$V_{CC}$ = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		$V_{CC}$ = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC}$ = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	$V_{CC}$ = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		$V_{CC}$ = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O}$ = -8 mA; $V_{CC}$ = 2.3 V	1.8	-	-	1.65	-	V
		$I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		$I_{O}$ = 4 mA; $V_{CC}$ = 1.65 V	-	-	0.45	-	0.65	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_0$ = 12 mA; $V_{CC}$ = 2.7 V	-	-	0.4	-	0.6	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
lı	input leakage current	$V_{CC}$ = 3.6 V; $V_{I}$ = 5.5 V or GND	-	±0.1	±5	-	±20	μA

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Symbol	Parameter	Conditions	–40 °C to +85 °C			–40 °C t	–40 °C to +125 °C	
			Min	Typ[1]	Max	Min	Max	
I <sub>CC</sub>	supply current	$V_{CC} = 3.6 \text{ V}; \text{ V}_{I} = V_{CC} \text{ or GND};$ $I_{O} = 0 \text{ A}$	-	0.1	10	-	40	μA
$\Delta I_{CC}$	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$	-	5	500	-	5000	μΑ
CI	input capacitance	$V_{CC} = 0 V$ to 3.6 V; $V_I = GND$ to $V_{CC}$	-	4.0	-	-	-	pF

#### Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

## **10.** Dynamic characteristics

#### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C t	o +125 °C	Unit
			-	Min	Typ <mark>[1]</mark>	Max	Min	Max	
t <sub>pd</sub>	propagation delay	An to $\overline{Y}n$ ; see Figure 6	[2]						
		V <sub>CC</sub> = 1.2 V		-	14	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		0.5	5.2	11.5	0.5	12.7	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.5	3.0	6.5	1.5	7.3	ns
		$V_{CC} = 2.7 V$		1.5	3.2	6.8	1.5	8.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.0	2.7	5.8	1.0	7.5	ns
		E3 to Yn; see Figure 6	[2]						
		V <sub>CC</sub> = 1.2 V		-	14	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.0	5.5	11.4	1.0	12.5	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.5	3.2	6.5	1.5	7.1	ns
		$V_{CC} = 2.7 V$		1.5	3.3	6.8	1.5	8.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.0	2.9	5.8	1.0	7.5	ns
		En to Yn; see Figure 7	[2]						
		V <sub>CC</sub> = 1.2 V		-	15	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.0	5.6	11.5	1.0	12.8	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.8	3.3	6.5	1.8	7.3	ns
		$V_{CC} = 2.7 V$		1.5	3.4	6.4	1.5	8.0	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.0	2.9	5.8	1.0	7.5	ns
t <sub>sk(o)</sub>	output skew time		[3]	-	-	1.0	-	1.5	ns

#### 3-to-8 line decoder/demultiplexer; inverting

Symbol	Parameter	Conditions		–40 °C to +85 °C			–40 °C to +125 °C		Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
C <sub>PD</sub> power dissipation capacitance	$V_I = GND$ to $V_{CC}$	<u>[4]</u>							
	capacitance	$V_{CC}$ = 1.65 V to 1.95 V		-	9.9	-			pF
		$V_{CC}$ = 2.3 V to 2.7 V		-	15.8	-			pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	21.1	-			pF

#### Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 8</u>.

[1] Typical values are measured at T<sub>amb</sub> = 25 °C and V<sub>CC</sub> = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \sum (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

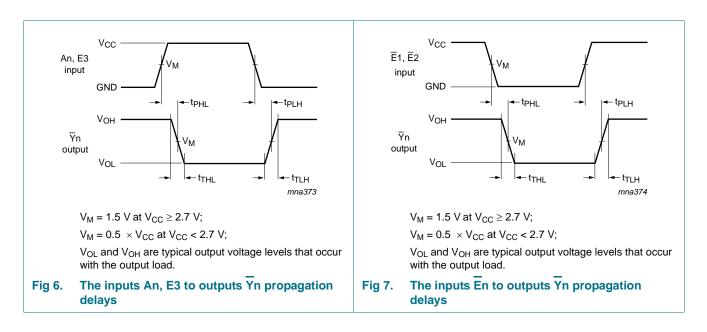
 $C_L$  = output load capacitance in pF

V<sub>CC</sub> = supply voltage in V

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs

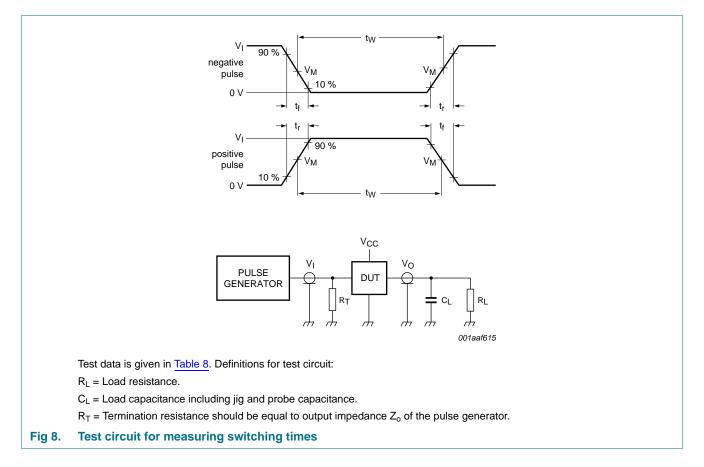
## 11. Waveforms



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#### Table 8. Test data

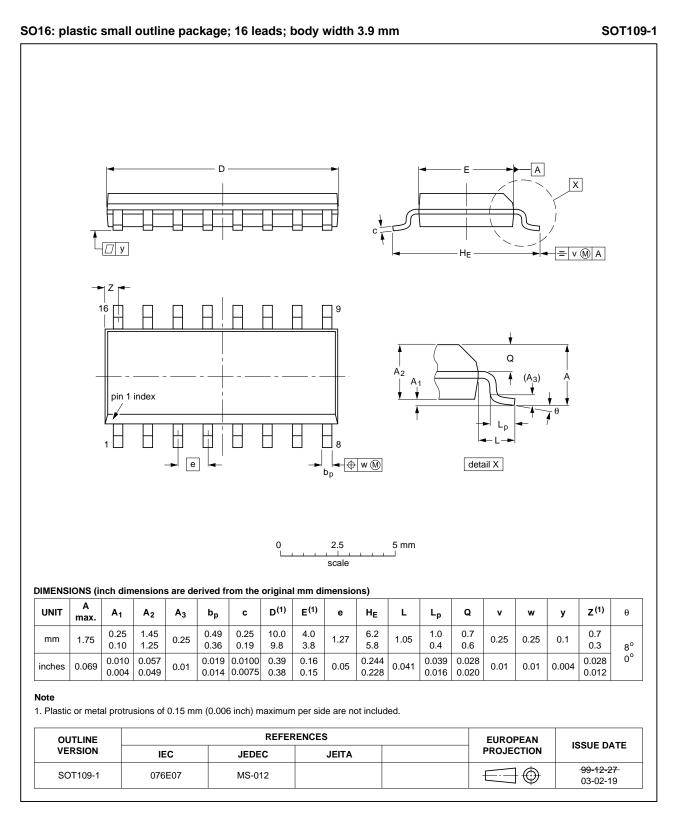
Supply voltage	Input		Load		
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	
1.2 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	
2.3 V to 2.7 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	500 Ω	
2.7 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	
3.0 V to 3.6 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	

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## 12. Package outline

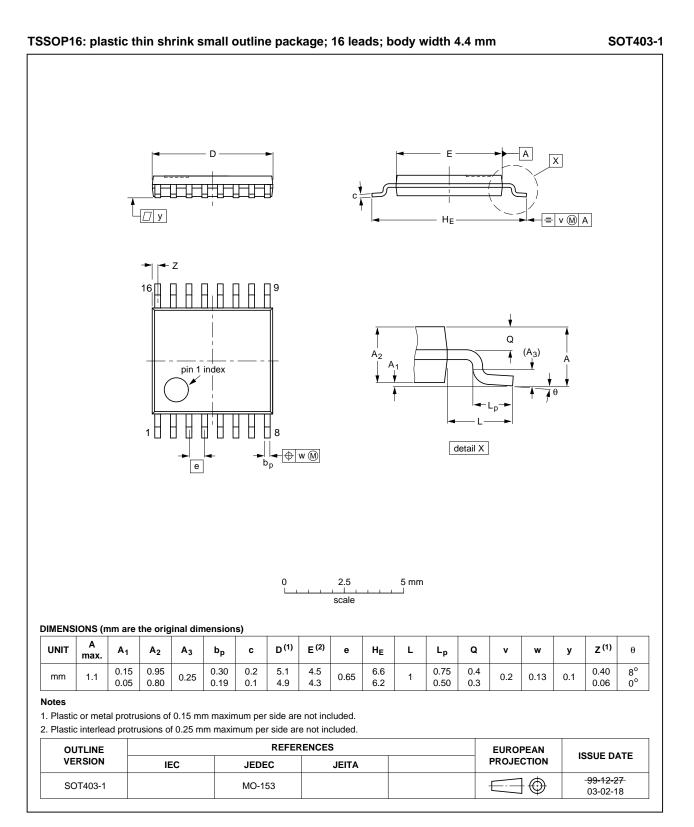


#### Fig 9. Package outline SOT109-1 (SO16)

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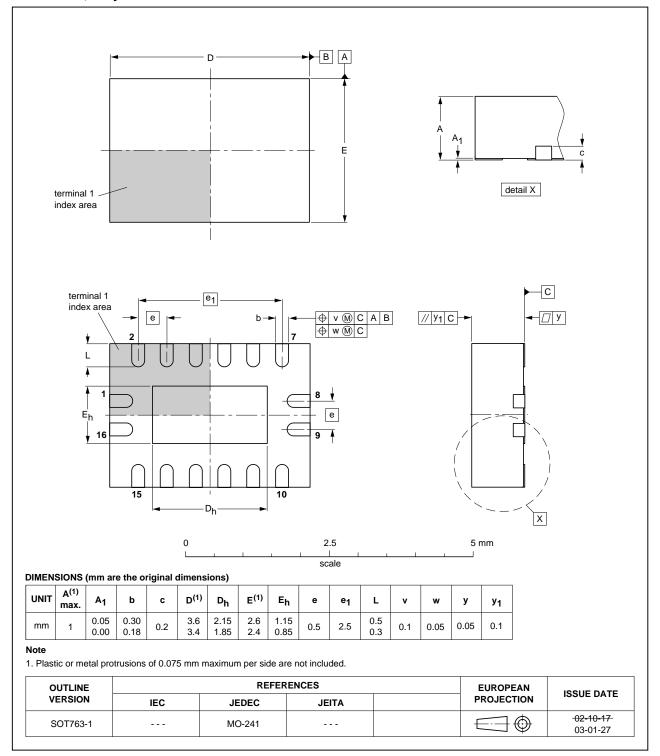


#### Fig 10. Package outline SOT403-1 (TSSOP16)

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DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

#### Fig 11. Package outline SOT763-1 (DHVQFN16)

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## **13. Abbreviations**

DUTDevice UESDElectroSt	tion Device Model
DUTDevice UESDElectroSt	Device Model
ESD ElectroSt	
	Inder Test
HBM Human B	tatic Discharge
	Body Model
MIL Military	
MM Machine	Model
TTL Transisto	pr-Transistor Logic

# 14. Revision history

Table 10. Revision history									
Document ID	Release date	Data sheet status	Change notice	Supersedes					
74LVC138A_Q100 v.1	20130404	Product data sheet	-	-					

3-to-8 line decoder/demultiplexer; inverting

## **15. Legal information**

#### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition	
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.	
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# 74LVC138A-Q100 Packaging Information





Type Number	Orderable Part Number	Package Name
74LVC138APW-Q100	74LVC138APW-Q100J	TSSOP16
74LVC138AD-Q100	74LVC138AD-Q100J	SO16
74LVC138ABQ-Q100	74LVC138ABQ-Q100X	DHVQFN16